SN54HC640, SN54HC643, SN54HC645 SN74HC640, SN74HC643, SN74HC645 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCLS003 D2684, DECEMBER 1982-REVISED JUNE 1989

- Choice of True or Inverting Logic
- High-Current 3-State Outputs Can Drive Up to 15 LSTTL Loads
- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs
- Dependable Texas Instruments Quality and Reliability

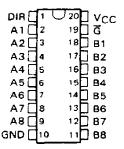
DEVICE	LOGIC
'HC640	Inverting
'HC643	True and Inverting
'HC645	True

description

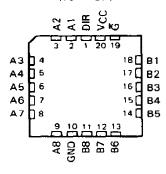
These octal bus transceivers are designed for asynchronous two-way communication between data buses. The devices transmit data from the A bus to the B bus or from the B bus to the A bus depending upon the level at the direction control (DIR) input. The enable input (G) can be used to disable the device so the buses are effectively isolated.

The SN54HC640, SN54HC643, and SN54HC645 are characterized for operation over the full military temperature range of ~55°C to 125°C. The SN74HC640, SN74HC643, and SN74HC645 are characterized for operation from ~40°C to 85°C.

SN54HC'...J PACKAGE SN74HC'...DW OR N PACKAGE (TOP VIEW)



SN54HC' . . . FK PACKAGE (TOP VIEW)

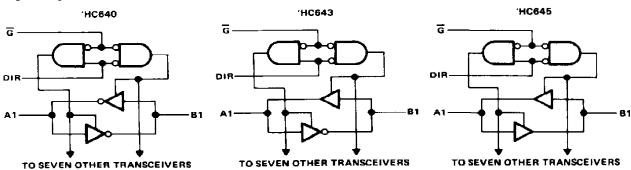


FUNCTION TABLE

CON	TROL	OPERATION									
INF	บาร	'HC640	'HC643	'HC645							
Ğ	DIR	HC040	HC043								
L	L	B data to A bus	B data to A bus	B data to A bus							
L	Н	A data to 8 bus	Ā data to B bus	A data to B bus							
н	х	Isolation	Isolation	Isolation							

logic symbols† **'HC643** 'HC645 'HC640 G (19) G (19) ō (19) 3 EN1 [BA] 3 EN1 (BA) 3 EN2 [AB] DIR 3 EN1 (BA) DIR DIR 3 EN2 [AB] 3 EN2 [AB] (18) B1 (18) B1 A1 (2) 118i 81 A1 A1 ŽΙ 25 \triangleright 2 7 A2 (3) **{3**I (17) (17) В2 A2 82 A2 A3 (4) (16) (16) (16) В3 В3 Δ3 83 A3 (15) A4 151 (15) (15) 84 A4 RA (14) B5 A5 (6) (14) A5 (6) 114) A5 (6) 85 85 13) 86 (13) B6 A6 -{13I A6 86 A6 112) B7 (12) (12) Α7 В7 A7 (11) 88 84 Α8

logic diagrams (positive logic)



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range[†]

Supply voltage, VCC	-0.5	V to 7 V
Input clamp current, IK (VI < 0 or VI > VCC)		± 20 mA
Output clamp current, IOK (VO < 0 or VO > VCC		± 20 mA
Continuous output current, IQ (VQ = 0 to VCC)		±35 mA
Continuous current through VCC or GND pins		± 70 mA
Lead temperature 1,6 mm (1/16 in) from case for 60 s: FK or J package		
Lead temperature 1,6 mm (1/16 in) from case for 10 s: DW or N package		. 260°C
Storage temperature range 6	55°C	to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		sı	N54HC6 N54HC6 N54HC6	43	SF	N74HC6 N74HC6 N74HC6	43	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	İ
VCC Supply voltage		2	5	6	2	5	6	٧
	V _{CC} = 2 V	1.5			1.5			
V _{IH} High-level input voltage	V _{CC} = 4.5 V	3.15			3.15			V
	V _{CC} = 6 V	4.2			4.2			1
	V _{CC} = 2 V	0		0.3	0		0.3	
V _{IL} Low-level input voltage	V _{CC} = 4.5 V	0		0.9	0		0.9	V
	V _{CC} = 6 V	0		1.2	0		1.2	
V _i Input voltage		0	•	Уcc	0		Vcc	
Vo Output voltage		0		Vcc	0	_	VCC	V
	V _{CC} = 2 V	0		1000	0		1000	
tt input transition (rise and fall) tir	nes VCC = 4.5 V	0		500	0		500	ពន
	V _{CC} = 6 V	0		400	o		400	
TA Operating free-air temperature		- 55		125	- 40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	VCC	T _A - 25°C			SN54HC840 SN54HC843 SN54HC845		SN74HC640 SN74HC643 SN74HC645		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
•		2 V	1.9	1.998		1.9		1.9		
	VI = VIH or VIL, IOH = -20 A	4.5 V	4.4	4.499		4.4		4.4		
Voн	1	6 0	5.9	5.999		5.9		5.9		V
	VI = VIH or VIL, IOH = -6 mA	4.5 V	3.98	4.30		3.7		3.84		
	V _L = V _{IH} or V _{IL} , I _{OH} = -7.8 mA	6 V	5.48	5.80		5.2		5.34		
		2 V		0.002	0.1		0.1		0.1	
	VI = VIH or VIL, IOL = 20 A	4.5 V		0.001	0.1		0.1		0.1	
VOL		6 V		0.001	0.1		0.1		0.1	V
	VI = VIH or VIL. IOL = 6 mA	4.5 V		0.17	0.26		0.4		0.33	
	VI = VIH or VIL, IOL = 7.8 mA	6 V		0.15	0.26	1	0.4		0.33	
lı DIR or G	VI = VCC or 0	6 V		±0.1	± 100		± 1000		± 1000	nΑ
OZ A or B	Vo = Vcc or 0	6 V		±0.01	±0.5		±10		± 5	μΑ
cc	V _I = V _{CC} or 0, I _O = 0	6 V		_	- 8		160		80	μΑ
C _i DIR or G		2 to 6 V		3	10		10		10	pF



SN54HC640, SN74HC640 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

switching characteristics over recommended operating free-air temperature range (unless otherwise noted), $C_L = 50$ pF (see Note 1)

DADAMETED	FROM	то		ΤA	- 25	°C	SN54	HC640	SN74	HC640	
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
		Ī	2 ∨		29	105		160	Ì	130	
tpd	A or B	B or A	4.5 V		10	21		32	}	26	ns
			6 V	l	8	18	İ	27		22	İ
[]			2 V		109	230		340		290	
ten	ত্ত	A or B	4.5 V		27	46	İ	68	ŀ	58	ns
			6 V		20	39	l	58	1	49	İ
Ì			2 V		40	150	ĺ	225	1	190	1
^t dis	<u> </u>	A or B	4.5 V		18	30		45	ł	38	ns
			6 V		16	26	ļ	38	1	32	İ
			2 V		20	60		90	ĺ	75	
tt		A or B	4.5 V		8	12		18	l	15	пъ
			6 V		6	10	1	15	İ	13	ļ

-	Cpd	Power dissipation capacitance per transceiver	No load, TA = 25 °C	40 pF typ

switching characteristics over recommended operating free-air temperature range (unless otherwise noted), $C_L = 150 \text{ pF}$ (see Note 1)

242445752	FROM	TO	U	Τ _A	- 25	°C	SN54	HC640	SN74	HC640	UNIT
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	* -		2 V		44	190		290		235	
^t pd	A or B	B or A	4.5 V		14	38		58		47	ns
•			6 🗸		11	33	1	49	ļ	41	
			2 V		124	315		470		395	
ten	G	A or B	4.5 V		31	63	1	94		79	ns
u.,			6 V		23	54		80		68	
·			2 V		45	210		315		265	
tt		A or B	4.5 V	1	17	42	1	63	1	53	ns
,			6 V		13	36	İ	53	1	45]

NOTE 1: Load circuit and voltage waveforms are shown in Section 1

SN54HC643, SN74HC643 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

switching characteristics over recommended operating free-air temperature range (unless otherwise noted), $C_L = 50$ pF (see Note 1)

DADAMETER	FROM	TO	\ \u	TA	_ 25	°C	6N54	HC643	SN74	HC643	
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V		29	110		165		140	
t _{pd}	A or B	B or A	4.5 V		10	22	ł	33		28	กร
			6 V		8	19	İ	28		24	
			2 V		109	230		340		290	
ten	G	A or B	4.5 V		27	46	ļ	68		58	กร
			6 V		20	39		58		49	
			2 V		40	150		225		190	
^t dis	ढ	A or B	4.5 V		18	30	l	45		38	กร
			6 V		16	26		38	į	32	
			2 V	1	20	60		90		75	· · ·
t _T		A or B	4.5 V	1	8	12		18	[15	ns
			6 V	1	6	10]	15		13	

Cpd	Power dissipation capacitance per transceiver	No load, T _A = 25°C	40 pF typ

switching characteristics over recommended operating free-air temperature range (unless otherwise noted), $C_L = 150 \, \mathrm{pF}$ (see Note 1)

PARAMETER	FROM	то		Τ _A	_ 25	°C	SN54	HC643	SN74	IC643	UNIT
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
			2 V		44	195		295		245	
^t pd	A or B	BorA	4.5 V		14	39		59	1	49	ns
			6 V		1 1	34	•	50	İ	43	
			2 V		124	315		470		395	
ten	ਰ	A or B	4.5 V		31	63		94		79	กร
			6 V	1	23	54		80		68	
			2 V		45	210		315		265	
tt		A or B	4.5 V		17	42		63		53	ns
			6 V	i	13	36		53		45	

NOTE 1: Load circuit and voltage waveforms are shown in Section 1.



SN54HC645, SN74HC645 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

switching characteristics over recommended operating free-air temperature range (unless otherwise noted), $C_L = 50$ pF (see Note 1)

	FROM	TO		Ta	= 25	°C	SN54	HC645	SN74	HC645	
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	XAM	MIN	MAX	MIN	MAX	UNIT
			2 V		40	105		160		130	
tpd	A or B	B or A	4.5 V		15	21		32		26	ns.
			6 V		12	18		27		22	
			2 V		125	230		340		290	
ten	Ğ	A or B	4.5 V		23	46		68		58	пв
			6 V		20	39		58		49	
			2 V		74	200		300		250	
t _{dis}	ढ	A or B	4.5 V		25	40	}	60	•	50	ns
			ВV	1	21	34	l	51	1	43	
			2 V	T	20	60		90		75	
tt		A or B	4.5 V	1	8	12		18		15	ns
-			6 V		6	10		15	ł	13	

C _{pd}	Power dissipation capacitance per transceiver	No load, TA = 25°C	40 pF typ

switching characteristics over recommended operating free-air temperature range (unless otherwise noted), $C_L = 150 \text{ pF}$ (see Note 1)

	FROM (INPUT)	TO (OUTPUT)	vcc	TA - 26°C		SN54HC645		SN74HC645			
PARAMETER				MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
¹pd			2 V		54	135		200		170	
	A or B	B or A	4.5 V		18	27		40	ł	34	กร
P3			6 V		15	23	1	34	•	29	1
ten			2 V		150	270		405		335	
	G	A or B	4.5 V		31	54	į	81	}	67	ns
			6 V		25	46		69	1	56	1
tţ		<u> </u>	2 V		45	210		315		265	
		A or B	4.5 V		17	42	1	63		53	пѕ
			6 V	1	13	36		53		45	İ

NOTE 1: Load circuit and voltage waveforms are shown in Section 1.



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